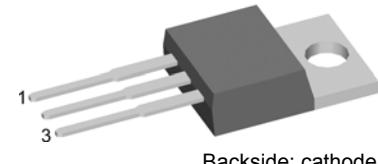
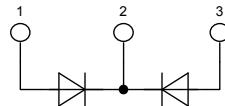


**HiPerFRED<sup>2</sup>**

High Performance Fast Recovery Diode  
Low Loss and Soft Recovery  
Common Cathode

## Part number

DPG 20 C 300 PB



Backside: cathode

**Features / Advantages:**

- Planar passivated chips
- Very low leakage current
- Very short recovery time
- Improved thermal behaviour
- Very low  $I_{rm}$ -values
- Very soft recovery behaviour
- Avalanche voltage rated for reliable operation
- Soft reverse recovery for low EMI/RFI
- Low  $I_{rm}$  reduces:
  - Power dissipation within the diode
  - Turn-on loss in the commutating switch

**Applications:**

- Antiparallel diode for high frequency switching devices
- Antisaturation diode
- Snubber diode
- Free wheeling diode
- Rectifiers in switch mode power supplies (SMPS)
- Uninterruptible power supplies (UPS)

**Package:**

- Housing: TO-220
- Industry standard outline
- Epoxy meets UL 94V-0
- RoHS compliant

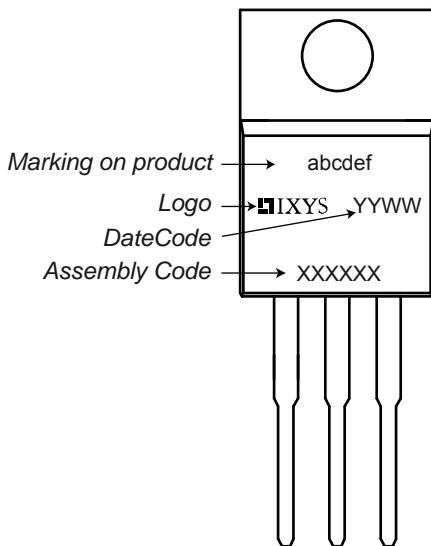
Symbol	Definition	Conditions		Ratings		
		min.	typ.	max.	Unit	
$V_{RRM}$	max. repetitive reverse voltage			300		V
$I_R$	reverse current	$V_R = 300\text{V}$	$T_{VJ} = 25^\circ\text{C}$		1	$\mu\text{A}$
		$V_R = 300\text{V}$	$T_{VJ} = 150^\circ\text{C}$		0.06	mA
$V_F$	forward voltage	$I_F = 10\text{A}$	$T_{VJ} = 25^\circ\text{C}$		1.27	V
		$I_F = 20\text{A}$			1.45	V
		$I_F = 10\text{A}$	$T_{VJ} = 150^\circ\text{C}$		0.98	V
		$I_F = 20\text{A}$			1.17	V
$I_{FAV}$	average forward current	rectangular	$d = 0.5$	$T_c = 145^\circ\text{C}$		A
$V_{FO}$	threshold voltage	$\left. \begin{array}{l} V_F \\ r_F \end{array} \right\}$ slope resistance } for power loss calculation only		$T_{VJ} = 175^\circ\text{C}$	0.74	V
$r_F$	slope resistance				17.7	$\text{m}\Omega$
$R_{thJC}$	thermal resistance junction to case				2.30	K/W
$T_{VJ}$	virtual junction temperature			-55	175	$^\circ\text{C}$
$P_{tot}$	total power dissipation				65	W
$I_{FSM}$	max. forward surge current	$t = 10\text{ ms}$ (50 Hz), sine		$T_{VJ} = 45^\circ\text{C}$		A
$I_{RM}$	max. reverse recovery current			$T_{VJ} = 25^\circ\text{C}$	3	A
		$I_F = 10\text{A}; V_R = 200\text{V}$		$T_{VJ} = 125^\circ\text{C}$	5.5	A
$t_{rr}$	reverse recovery time	$-di_F/dt = 200\text{ A}/\mu\text{s}$		$T_{VJ} = 25^\circ\text{C}$	35	ns
				$T_{VJ} = 125^\circ\text{C}$	45	ns
$C_J$	junction capacitance	$V_R = 150\text{V}; f = 1\text{ MHz}$		$T_{VJ} = 25^\circ\text{C}$	15	pF

Symbol	Definition	Conditions	Ratings			
			min.	typ.	max.	
$I_{RMS}$	RMS current	per pin <sup>1)</sup>			35	A
$R_{thCH}$	thermal resistance case to heatsink			0.50		K/W
$T_{stg}$	storage temperature		-55		150	°C
<b>Weight</b>				2		g
$M_D$	mounting torque		0.4		0.6	Nm
$F_c$	mounting force with clip		20		60	N

<sup>1)</sup>  $I_{RMS}$  is typically limited by: 1. pin-to-chip resistance; or by 2. current capability of the chip.

In case of 1, a common cathode/anode configuration and a non-isolated backside, the whole current capability can be used by connecting the backside.

### Product Marking



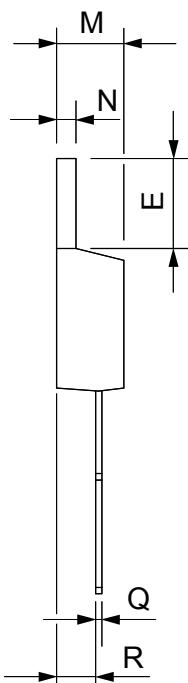
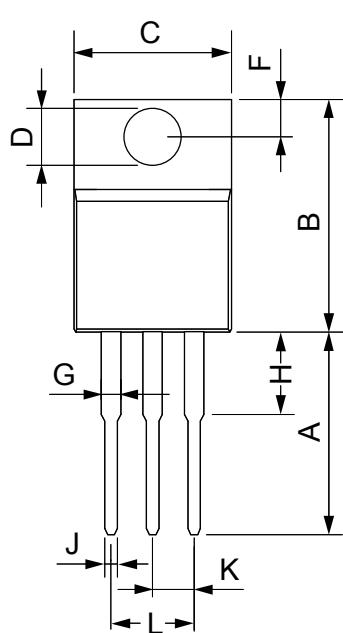
### Part number

D = Diode  
 P = HiPerFRED  
 G = extreme fast  
 20 = Current Rating [A]  
 C = Common Cathode  
 300 = Reverse Voltage [V]  
 PB = TO-220AB (3)

Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Code Key
Standard	DPG 20 C 300 PB	DPG20C300PB	Tube	50	504134

Similar Part	Package	Voltage Class
DPG20C300PN	TO-220ABFP (3)	300

## Outlines TO-220



Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	12.70	13.97	0.500	0.550
B	14.73	16.00	0.580	0.630
C	9.91	10.66	0.390	0.420
D	3.54	4.08	0.139	0.161
E	5.85	6.85	0.230	0.270
F	2.54	3.18	0.100	0.125
G	1.15	1.65	0.045	0.065
H	2.79	5.84	0.110	0.230
J	0.64	1.01	0.025	0.040
K	2.54	BSC	0.100	BSC
M	4.32	4.82	0.170	0.190
N	1.14	1.39	0.045	0.055
Q	0.35	0.56	0.014	0.022
R	2.29	2.79	0.090	0.110

